

APPLICABLE STANDARD							
RATING	OPERATING TEMPERATURE RANGE	-35°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE3)			
	OPERATING HUMIDITY RANGE	20 % TO 80 % (NOTE2)	STORAGE HUMIDITY RANGE	40 % TO 70 % (NOTE3)			
	VOLTAGE	AC/DC 100V	APPLICABLE CONNECTOR	DF50-*DS-1C			
	CURRENT	AWG 28 : 1.0 A AWG 30 : 0.9 A AWG 32 : 0.7 A	APPLICABLE CONTACT	DF50-2830SCFA DF50-3032SCFA			
SPECIFICATIONS							
ITEM		TEST METHOD		REQUIREMENTS		QT	AT
CONSTRUCTION							
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.		X	X
MARKING		CONFIRMED VISUALLY.				X	X
ELECTRIC CHARACTERISTICS							
CONTACT RESISTANCE		AC 20mV MAX 1mA (DC OR 1000 Hz).		30mΩ MAX.		X	—
INSULATION RESISTANCE		100V DC.		500MΩ MIN.		X	—
VOLTAGE PROOF		300V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.		X	—
MECHANICAL CHARACTERISTICS							
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 10 CYCLE FOR EACH, FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.					
ENVIRONMENTAL CHARACTERISTICS							
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 100MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→+85°C TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.		① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
	COUNT	DESCRIPTION OF REVISIONS		DESIGNED		CHECKED	DATE
							
				APPROVED	TS. SAKATA	09. 09. 07	
				CHECKED	MN. KENJO	09. 09. 07	
				DESIGNED	TT. OHSAKO	09. 09. 07	
				DRAWN	TT. OHSAKO	09. 09. 07	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DRAWING NO.		ELC4-326227-00	
	SPECIFICATION SHEET			PART NO.	DF50-*DP-1V (51)		
	HIROSE ELECTRIC CO., LTD.			CODE NO.	CL665-	0	1/2

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	X	—
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 220°C WITHIN 60 sec «PREHEATING AREA» 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—

REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD

AFTER PCB BOARD OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specified, refer to JIS C 5402.

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HRS	SPECIFICATION SHEET	PART NO.	DF50-*DP-1V (51)		
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL665-		2/2